

T591D226M025ATE060

T591, Tantalum, Polymer Tantalum, 22 uF, 20%, 25 VDC, SMD, Polymer, Molded, Low ESR, 60 mOhms, 7343, Height Max = 3.1mm

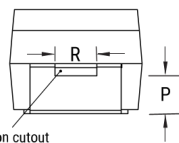
CATHODE (-) END VIEW



SIDE VIEW



ANODE (+) END VIEW



Termination cutout at KEMET's option, either end

BOTTOM VIEW



Click [here](#) for the 3D model.

Dimensions

Footprint	7343
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
H	2.8mm +/-0.3mm
T	0.13mm REF
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
A	3.8mm MIN
B	0.5mm +/-0.15mm
P	0.9mm REF
R	1mm REF
X	0.1mm +/-0.1mm

Packaging Specifications

Packaging	T&R, 178mm
Packaging Quantity	500

General Information

Series	T591
Dielectric	Polymer Tantalum
Style	SMD Chip
Description	SMD, Polymer, Molded, Low ESR
Features	Automotive
RoHS	Yes
Termination	Tin
Qualifications	AEC-Q200 (Limited 500 Hrs 85C/85% RH/Ur)
AEC-Q200	Subject to PPAP/PSW and change control
Component Weight	434.8 mg
Shelf Life	52 Weeks
MSL	3

Specifications

Capacitance	22 uF
Capacitance Tolerance	20%
Voltage DC	25 VDC (105C), 13.5 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	105°C
Humidity	85C, 85% RH, load, 500 Hours
Dissipation Factor	10% 120Hz 25C
Failure Rate	N/A
Resistance	60 mOhms (100kHz 25C)
Ripple Current	2740 mA (rms, 100kHz 45C), 1918 mA (rms, 105C), 685 mA (rms, 125C)
Leakage Current	55 uA (5min 25°C)